AMC631C

Integrated RAID HBA with SAS Expander, AMC



Key Features

- Host Bus Adapter (HBA) for off board SATA and SAS-3 (12 Gbps) drives
- Single module, mid-size per AMC.0
- Integrated RAID 0, 1, 1E, and 10
- PCle Gen3 x8 or x4 on ports 4-11, AMC.1 compliant
- SAS-3/SATA III x4 lanes on ports 12-15 and ports 17-20
- Additional x24 lanes on tongue 2

Benefits

- PCle Gen3 provides very high-speed host communication
- Basis for flexible high-performance storage sub-system configurations
- Fault tolerant data storage
- Conduction cooled solution
- Electrical, mechanical, software, and system-level expertise in house
- Full system supply from industry leader
- AS9100 and ISO9001 certified company





AMC631C

The AMC631C is an integrated RAID with a Host Bus Adapter for SATA III or SAS-3 drives located in other slots and routed across the backplane, supporting integrated RAID 0 (striping), 1 (mirroring), 1E, and 10 (mirroring and block-level striping).

This makes it suitable for use with high-performance SSD modules to form a compact fault-tolerant storage sub-system. The high bandwidth host interconnect, and the platform management capability inherent in MicroTCA, mean the module is ideal for high-energy research, high end instrumentation, and mil/aero signal acquisition systems.

The AMC631C routes its SAS/SATA ports to Ports 12-15 and 17-20. This allows expansion to other SAS Expanders or disks via the backplane routing (e.g. see VadaTech AMC632C). There are additional x24 ports on tongue 2 connecter routed from the on-board SAS expander, which can be used to support external drives or other AMCs (depending on backplane routing).

The AMC631C is available in rugged conduction-cooled (MTCA.2 or MTCA.3) versions.



Figure 1: AMC631C

Block Diagram

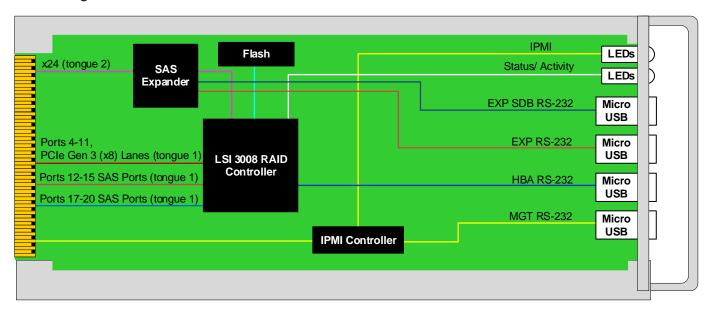


Figure 2: AMC631C Functional Block Diagram

Front Panel

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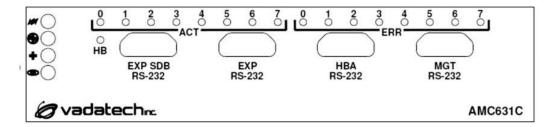


Figure 3: AMC631C Front Panel

Specifications

Architecture			
Physical	Dimensions	Single module, mid-size (full-size optional)	
		Width: 2.89" (73.5 mm)	
		Depth 7.11" (180.6 mm)	
Туре	AMC Storage	Integrated RAID (0, 1, 1E and 10)	
		Host Controller with SAS Expander	
Standards			
AMC	Туре	AMC.0 and AMC.1	
Module Management	IPMI	IPMI v2.0	
PCle	Lanes	PCIe Gen 3, x8 (or x4) on tongue 1	
SAS	Lanes	Ports 12-15 and 17-20 on tongue 1	
		x24 on tongue 2	
Configuration			
Power	AMC631C	10 W	
Environmental	Temperature	See ordering options and environmental spec sheet	
		Storage Temperature: –40° to +85°C with the disk	
	Vibration	Operating 9.8 m/s ² (1G), 5 to 500 Hz	
	Shock	Operating 325 G/2 ms, 160 G/1 ms	
	•	5 to 95% non-condensing	
Front Panel	Interface Connectors	4x RS-232 (MGT, HBA, EXP and EXP SDB)	
	LEDs	IPMI management control	
		Activity, Fault and Heartbeat	
		Wedgelocks (AMC631CC)	
Software Support	Operating System	Linux, Windows, Solaris and VxWorks	
Other			
MTBF	MIL Hand book 217-F@ TBD hrs		
Certifications	Designed to meet FCC, CE and UL certifications, where applicable		
Standards	VadaTech is certified to both the ISO9001:2000 and AS9100B:2004 standards		
Warranty	Two (2) years		

INTEGRATION SERVICES AND APPLICATION-READY PLATFORMS

VadaTech has a full ecosystem of OpenVPX, ATCA and MTCA products including chassis platforms, shelf managers, AMC modules, Switch and Payload Boards, Rear Transition Modules (RTMs), Power Modules, and more. The company also offers integration services as well as preconfigured Application-Ready Platforms. Please contact VadaTech Sales for more information.

Ordering Options

AMC631C - A0C-000-00J

A = PCle	
1 = PCle x4 2 = PCle x8	
C = Ruggedization Level*	J = Temperature Range and Coating
0 = No ruggedization 1 = Contact VadaTech 2 = Contact VadaTech 3 = Contact VadaTech	0 = Commercial (-5° to +55°C), No coating 1 = Commercial (-5° to +55°C), Humiseal 1A33 Polyurethane 2 = Commercial (-5° to +55°C), Humiseal 1B31 Acrylic 3 = Industrial (-20° to +70°C), No coating 4 = Industrial (-20° to +70°C), Humiseal 1A33 Polyurethane 5 = Industrial (-20° to +70°C), Humiseal 1B31 Acrylic 6 = Extended (-40° to +85°C), Humiseal 1A33 Polyurethane** 7 = Extended (-40° to +85°C), Humiseal 1B31 Acrylic**

Notes: * Ruggedization level is per the MTCA.2 and MTCA.3 specification.

Related Products



- MTCA.3 Conduction Cooled System Platform
- 1/2 Short Air Transport Rack (ATR) per ARNIC404A, with no internal fan (12.62" deep without handle)
- Customized Front Input/Output (I/O) Panel Connector layout per customer requirement (option per MIL-DTL-M38999)



- Conduction cooled
- Dual AD9129 DAC, 14-bit at 5.7 GSPS (2.85 GSPS direct RF synthesis)
- Single module, mid-size per AMC.0



- Conduction cooled
- Intel® Xeon™ E3 processor
- Single module, mid-size per AMC.0

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^{**} At the edge of the module for conduction cooled.

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